



SNS COLLEGE OF TECHNOLOGY

(An Autonomous Institution)
COIMBATORE-35

Accredited by NBA-AICTE and Accredited by NAAC – UGC with A+ Grade
Approved by AICTE, New Delhi & Affiliated to Anna University, Chennai



DEPARTMENT OF ELECTRICAL AND ELECTRONICS ENGINEERING

19EET202 / ANALOG ELECTRONICS II YEAR / III SEMESTER

UNIT-I: PN JUNCTION DEVICE

The Insulated Gate Bipolar Transistor (IGBT)



TOPIC OUTLINE



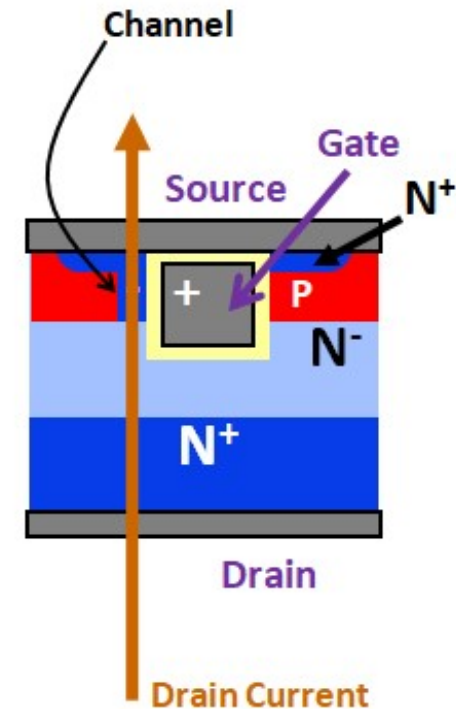
•The main topics to be addressed in this lesson are the following:

- **Introduction.**
- **Review of the basic structure and operation of bipolar junction transistors (BJTs).**
- **Internal structures of IGBTs.**
- **Static characteristics of the IGBTs.**
- **Dynamic characteristics of the IGBTs.**
- **Losses in the IGBTs.**



Introduction

- Power MOSFETs are excellent power devices to be used in power converters up to a few kW.
- They have good switching characteristics because they are unipolar devices.
- This means that the current is due to majority carriers exclusively and that it does not pass through any PN junction.
- Due to this, conductivity modulation does not take place.

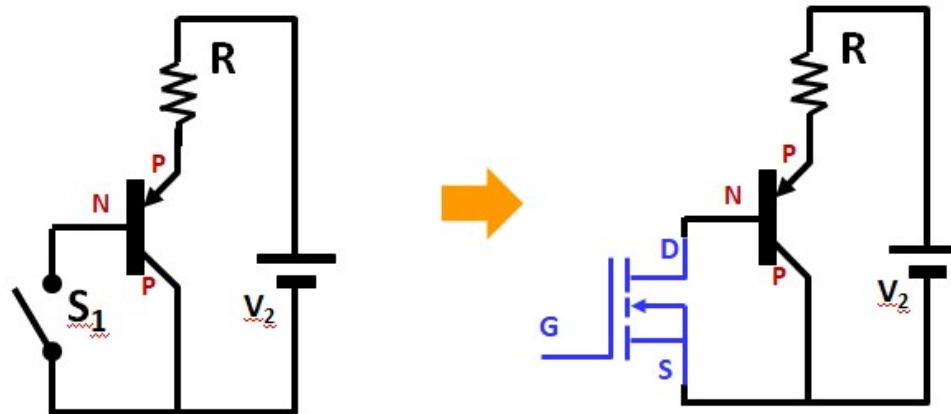




Principle of operation and structure of the IGBT

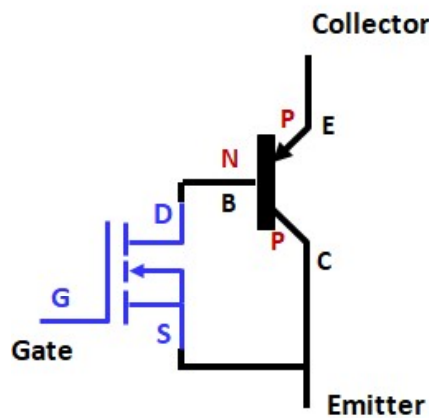


- The IGBT (the Insulated Gate Bipolar Transistor) is based on a structure that allows:
 - Conductivity modulation (good behaviour for high voltage devices when they are in on-state).
 - Anti-saturation (not so slow switching process as in the case of complete saturation).
 - And control from an insulated gate (as in the case of a MOSFET).

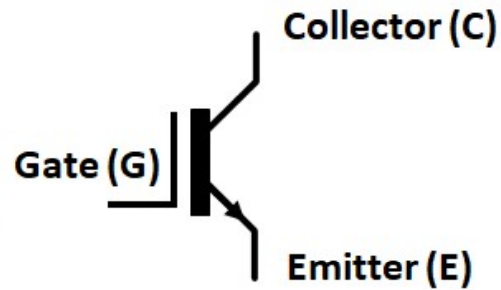




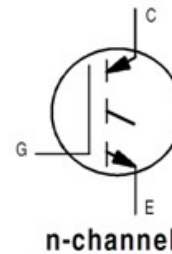
Principle of operation and structure of the IGBT (



Simplified equivalent circuit for an IGBT.

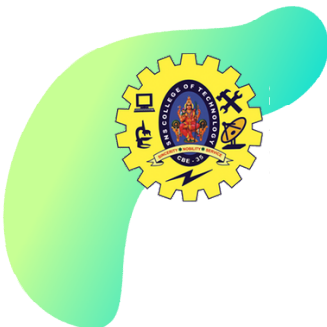


Schematic symbol for a N-channel IGBT.



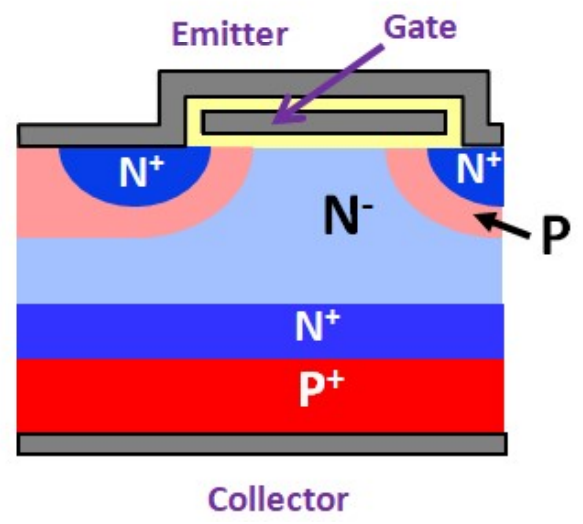
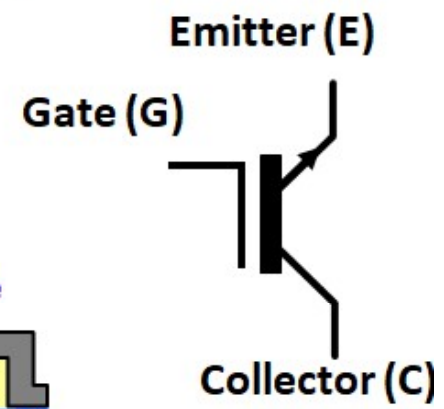
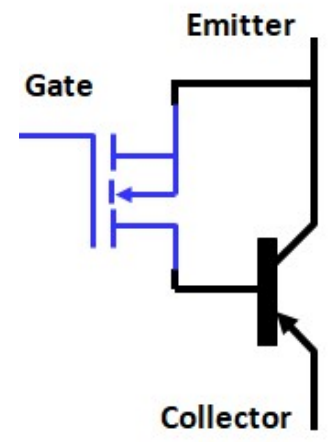
Another schematic symbol also used.

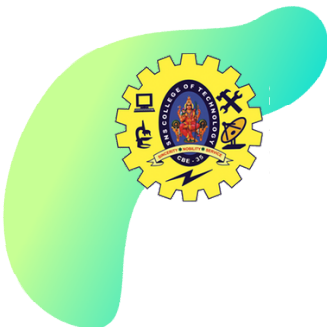




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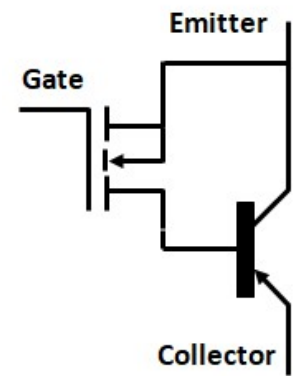
- Internal structure (I).



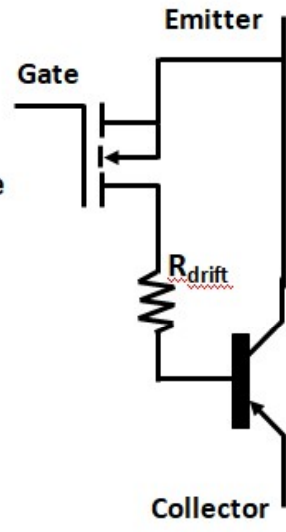
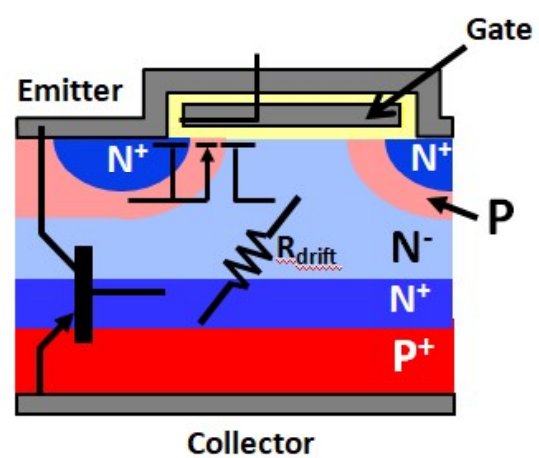


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- Internal structure (II).



Simplest model for an IGBT.



Model taking into account the drift region resistance.

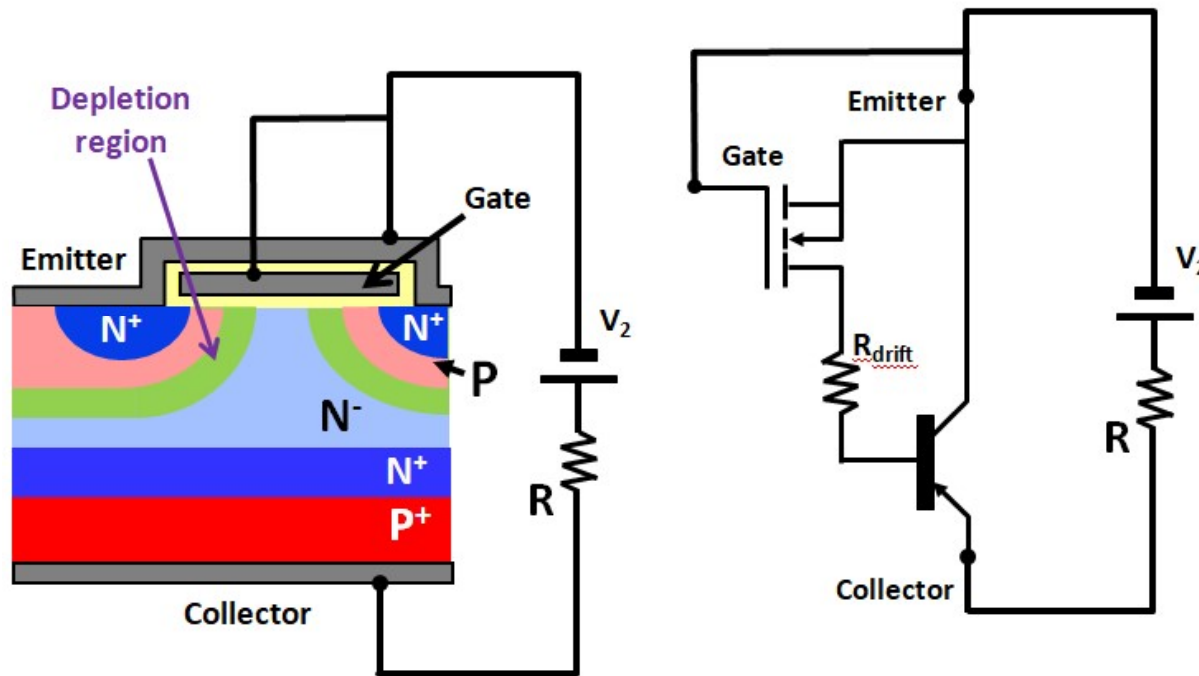




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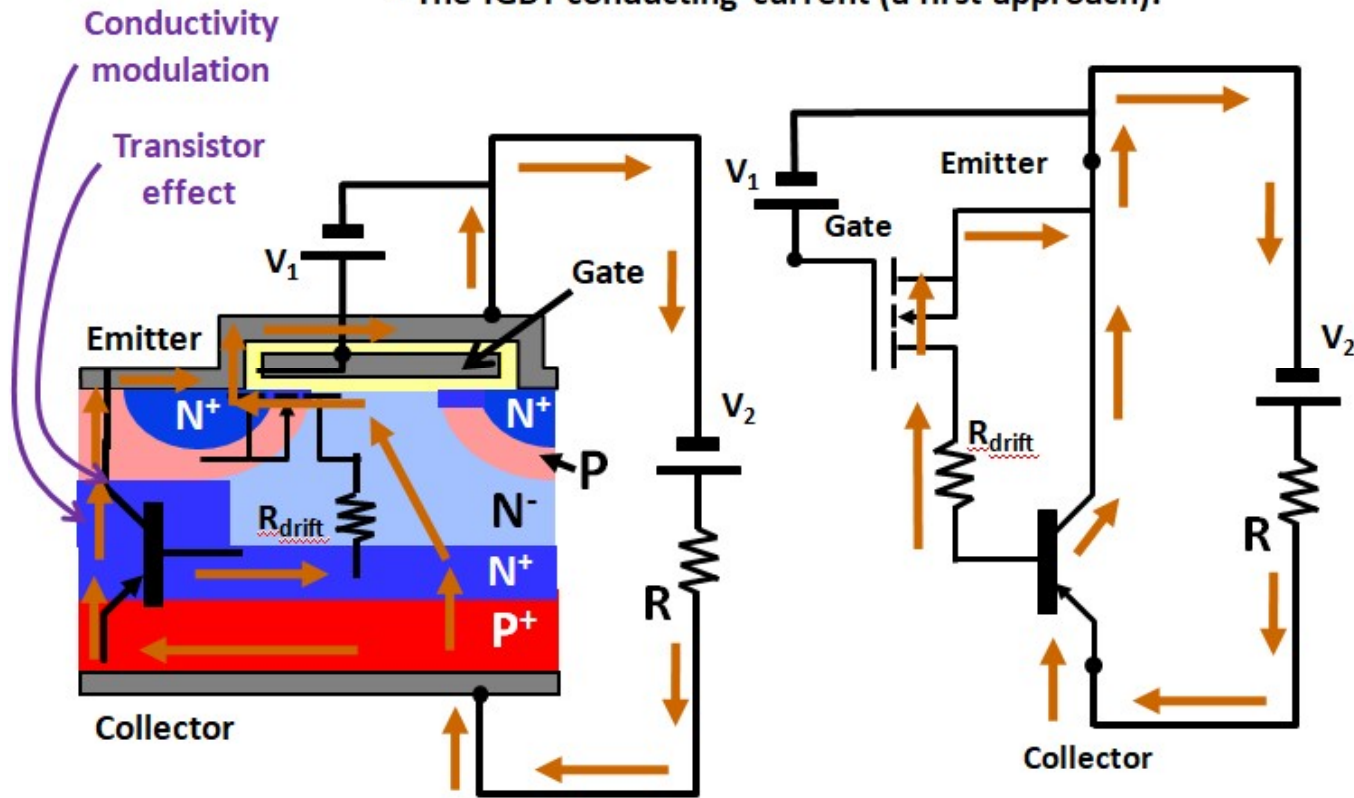
- The IGBT blocking (withstanding) voltage.





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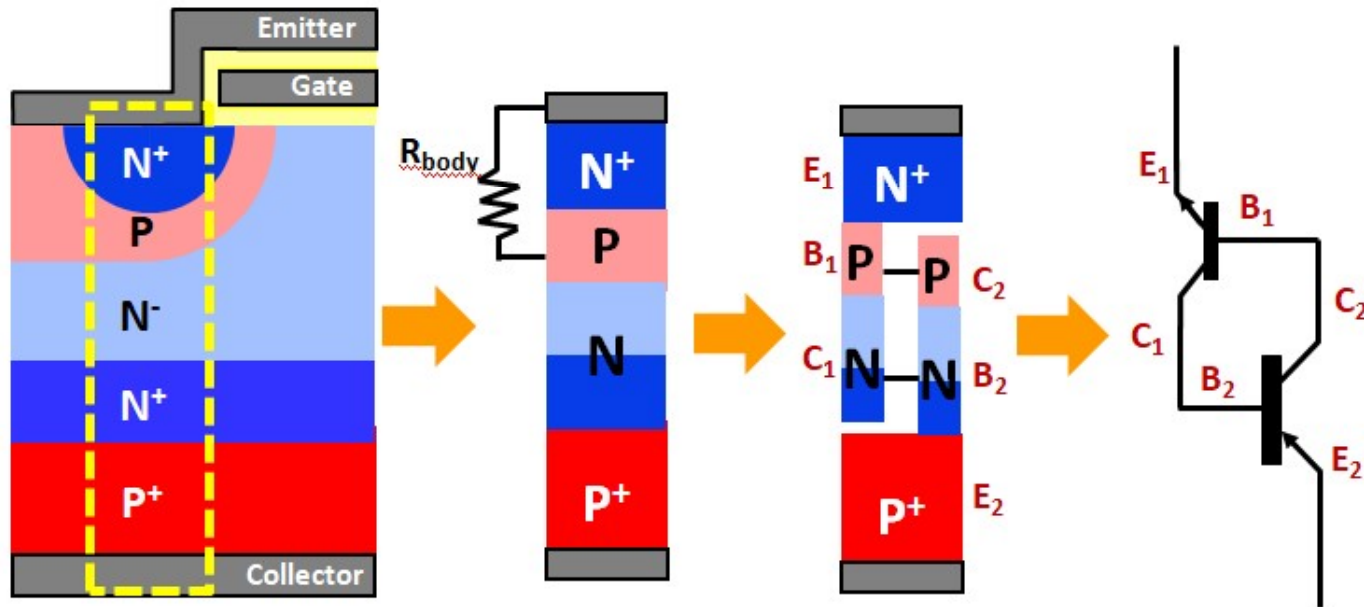
- The IGBT conducting current (a first approach).





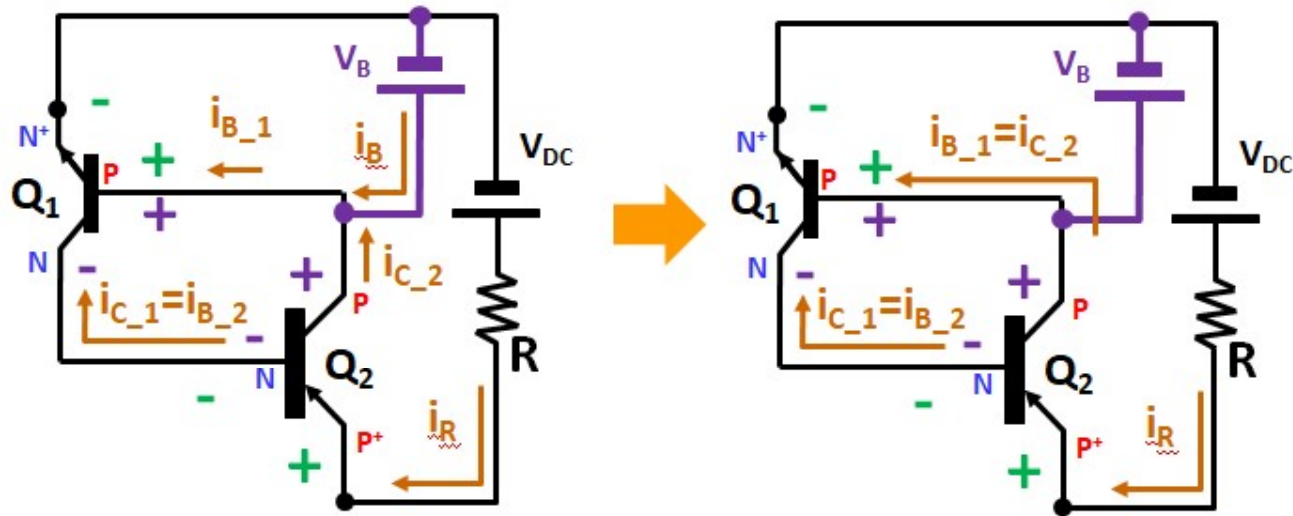
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- The basics of the thyristor: the PNPN structure (I).





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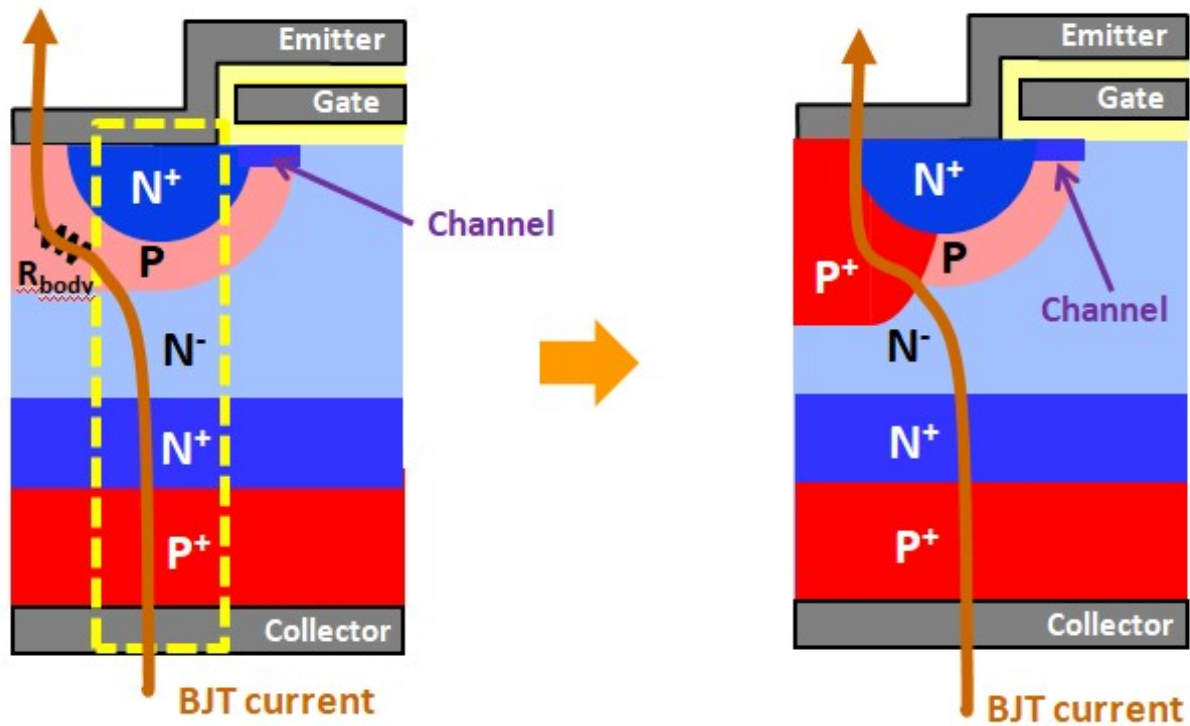


- Initially, the current needed for transistor Q_1 to start conducting (active region) comes from the voltage source V_B .
- When i_{C_1} increases, i_{C_2} strongly increases because $i_{C_2} = \beta_2 \cdot i_{B_2} = \beta_2 \cdot i_{C_1}$. Therefore, current i_{B_1} will be mainly due to i_{C_2} .
- As i_{C_2} is the main current needed to maintain both transistors saturated, the situation does not change if we remove V_B .



LATCH UP

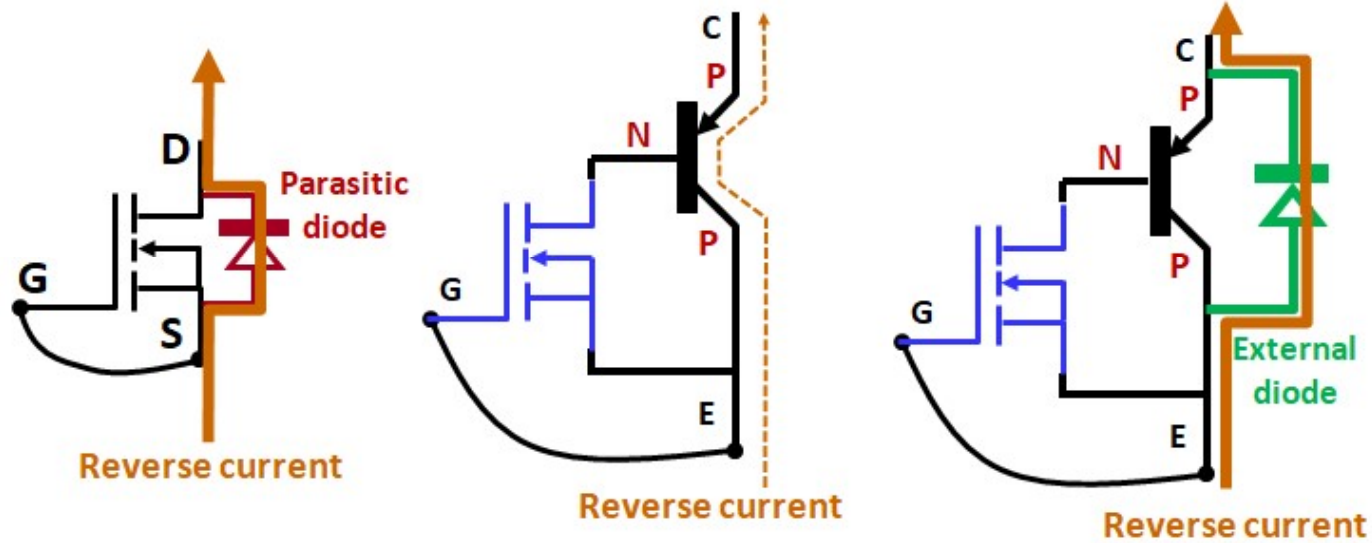
- To avoid the IGBT latch-up, R_{body} must be as low as possible.





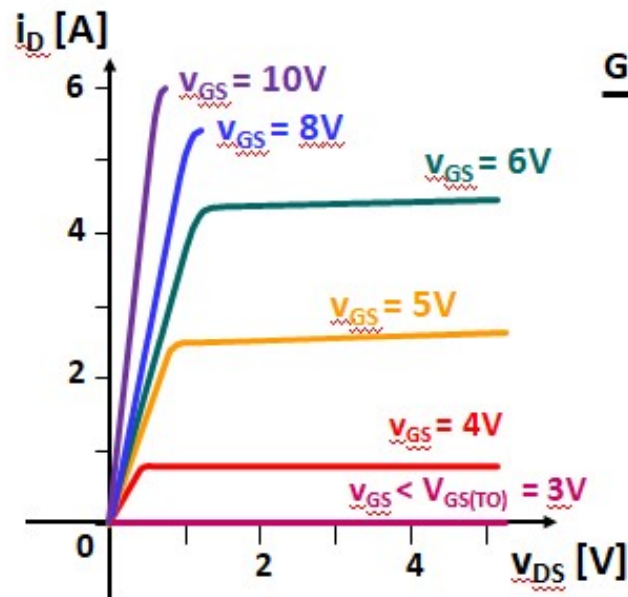
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- The IGBT cannot conduct reverse current when $v_{GE} = 0$ (it is not as the MOSFET).

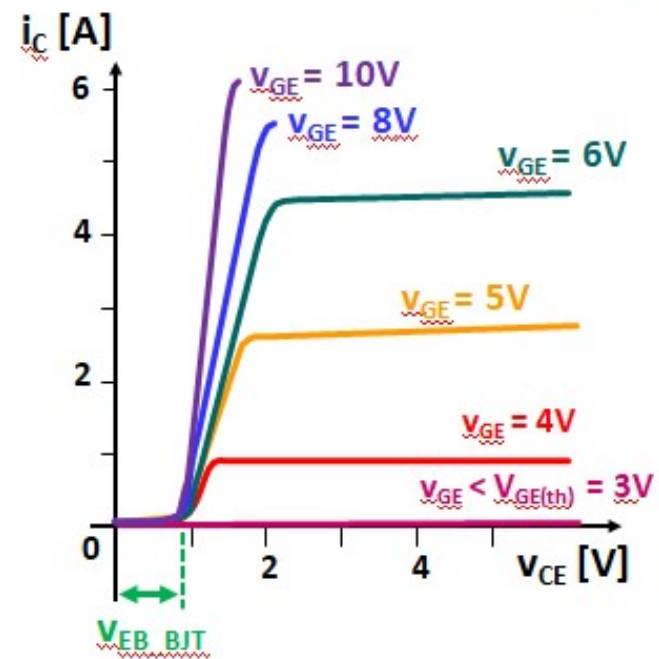
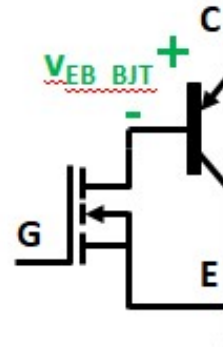


- This means that it is able to block reverse voltage.





- Static output characteristic curve of a MOSFET.
- It is also the one corresponding to the MOSFET part of a IGBT.



- Static output characteristic curve of a IGBT.
- It can be easily obtained from the MOSFET characteristic curve by adding the voltage drop v_EB BJT corresponding to the emitter-to-base junction of the BJT part of the IGBT.

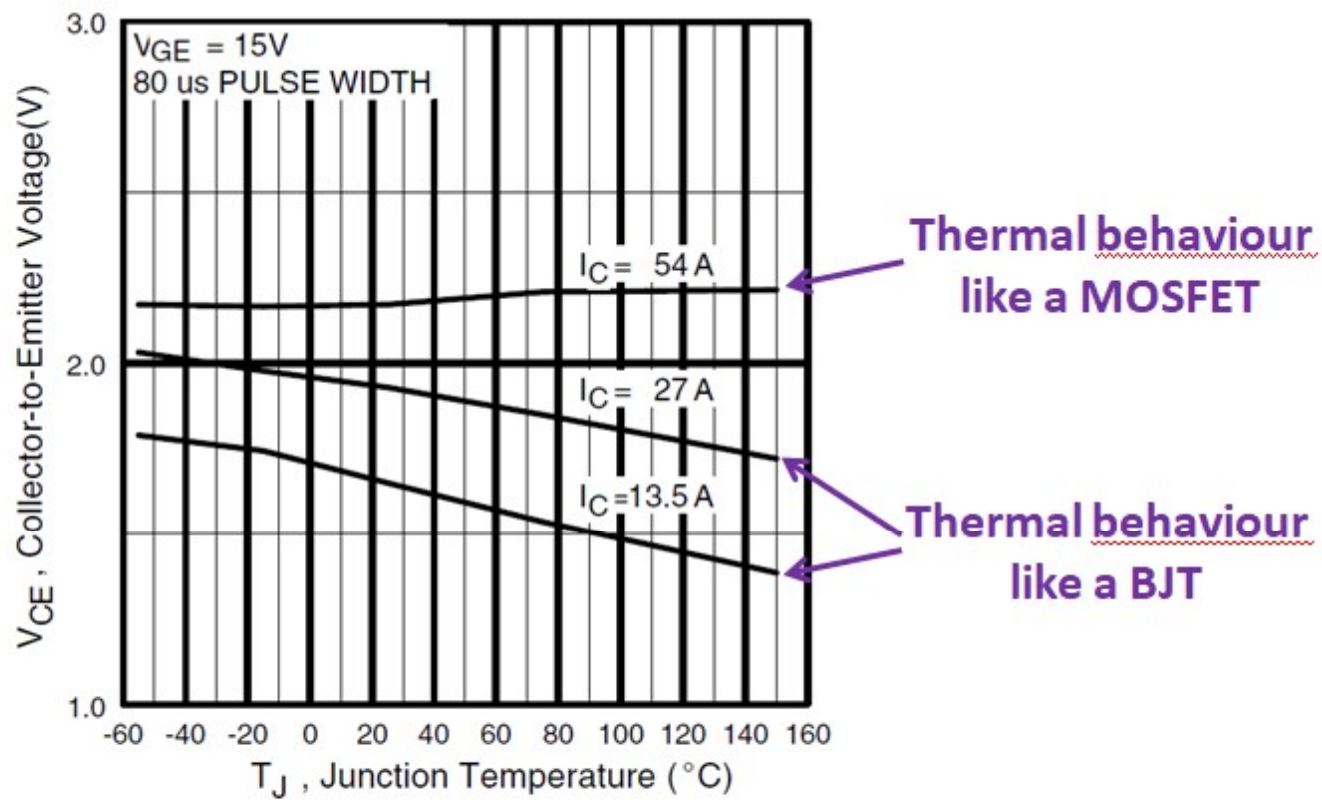
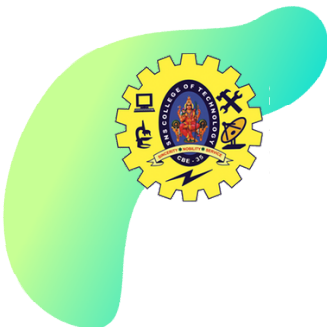
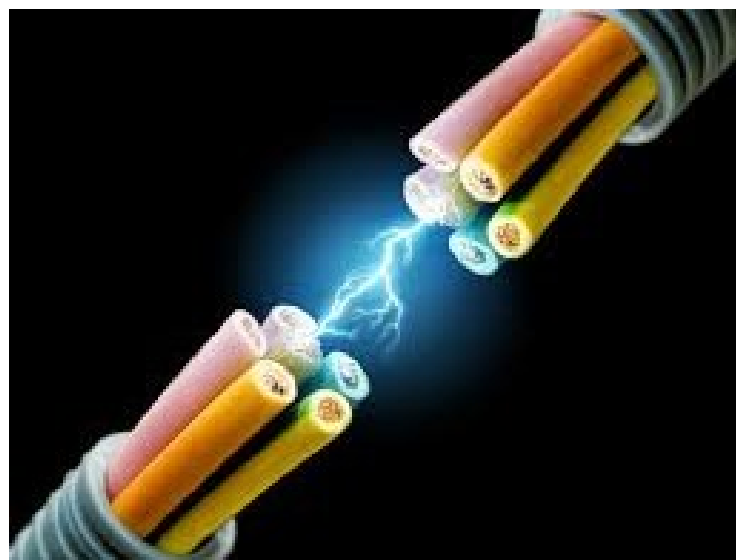


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature





RECAP....



...THANK YOU

